

Dual N-channel MOSFET

ELM14822AA-N

■General description

ELM14822AA-N uses advanced trench technology to provide excellent $R_{ds(on)}$ and low gate charge.

■Features

- $V_{ds}=30V$
- $I_d=8.5A$ ($V_{gs}=10V$)
- $R_{ds(on)} < 16m\Omega$ ($V_{gs}=10V$)
- $R_{ds(on)} < 26m\Omega$ ($V_{gs}=4.5V$)

■Maximum absolute ratings

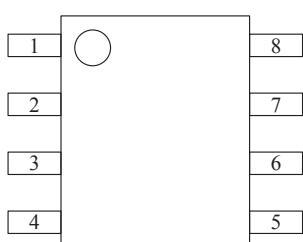
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	V_{ds}	30	V	
Gate-source voltage	V_{gs}	± 20	V	
Continuous drain current Ta=25°C	I_d	8.5	A	1
Ta=70°C	I_d	6.6		
Pulsed drain current	I_{dm}	30	A	2
Power dissipation Ta=25°C	P_d	2.00	W	
Ta=70°C	P_d	1.28		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	°C	

■Thermal characteristics

Parameter	Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$R_{\theta ja}$	48.0	62.5	°C/W	1
Maximum junction-to-ambient	$R_{\theta ja}$	74.0	110.0	°C/W	
Maximum junction-to-lead	$R_{\theta jl}$	35.0	40.0	°C/W	3

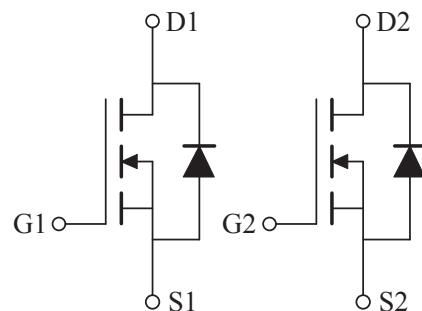
■Pin configuration

SOP-8(TOP VIEW)



Pin No.	Pin name
1	SOURCE2
2	GATE2
3	SOURCE1
4	GATE1
5	DRAIN1
6	DRAIN1
7	DRAIN2
8	DRAIN2

■Circuit



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■Electrical characteristics

T_a=25°C

Parameter	Symbol	Condition		Min.	Typ.	Max.	Unit	
STATIC PARAMETERS								
Drain-source breakdown voltage	BVdss	Id=250µA, Vgs=0V		30			V	
Zero gate voltage drain current	Idss	Vds=24V, Vgs=0V	Tj=55°C			1	µA	
						5		
Gate-body leakage current	Igss	Vds=0V, Vgs=±20V				100	nA	
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=250µA		1.0	1.8	3.0	V	
On state drain current	Id(on)	Vgs=10V, Vds=5V		30			A	
Static drain-source on-resistance	Rds(on)	Vgs=10V, Id=8.5A	Tj=125°C		13.4	16.0	mΩ	
					20.0	25.0		
		Vgs=4.5V, Id=6A			21.0	26.0	mΩ	
Forward transconductance	Gfs	Vds=5V, Id=8.5A			23		S	
Diode forward voltage	Vsd	Is=1A, Vgs=0V			0.76	1.00	V	
Max. body-diode continuous current	Is					3	A	
DYNAMIC PARAMETERS								
Input capacitance	Ciss	Vgs=0V, Vds=15V, f=1MHz			1040	1250	pF	
Output capacitance	Coss				180		pF	
Reverse transfer capacitance	Crss				110		pF	
Gate resistance	Rg	Vgs=0V, Vds=0V, f=1MHz			0.70	0.85	Ω	
SWITCHING PARAMETERS								
Total gate charge (10V)	Qg	Vgs=10V, Vds=15V, Id=8.5A			19.20	23.00	nC	
Total gate charge (4.5V)	Qg				9.36	11.20	nC	
Gate-source charge	Qgs				2.60		nC	
Gate-drain charge	Qgd				4.20		nC	
Turn-on delay time	td(on)	Vgs=10V, Vds=15V Rl=1.8Ω, Rgen=3Ω			5.2	7.5	ns	
Turn-on rise time	tr				4.4	6.5	ns	
Turn-off delay time	td(off)				17.3	25.0	ns	
Turn-off fall time	tf				3.3	5.0	ns	
Body diode reverse recovery time	trr	If=8.5A, dl/dt=100A/µs			16.7	21.0	ns	
Body diode reverse recovery charge	Qrr	If=8.5A, dl/dt=100A/µs			6.7	10.0	nC	

NOTE :

1. The value of R_{θja} is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with T_a=25°C. The value in any given applications depends on the user's specific board design. The current rating is based on the t ≤ 10s thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The R_{θja} is the sum of the thermal impedance from junction to lead R_{θjl} and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80µs pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_a=25°C. The SOA curve provides a single pulse rating.



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■ Typical electrical and thermal characteristics

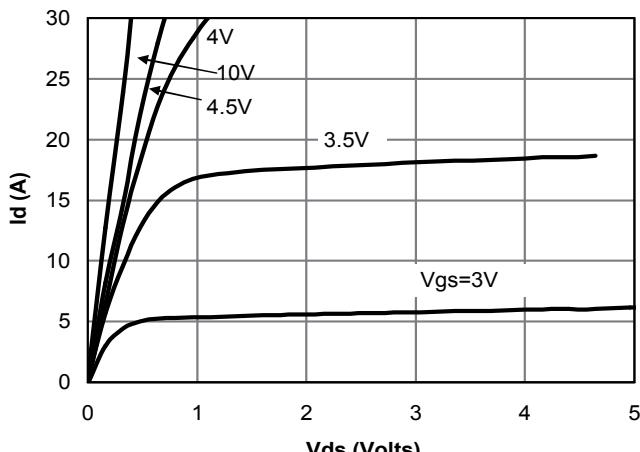


Fig 1: On-Region Characteristics

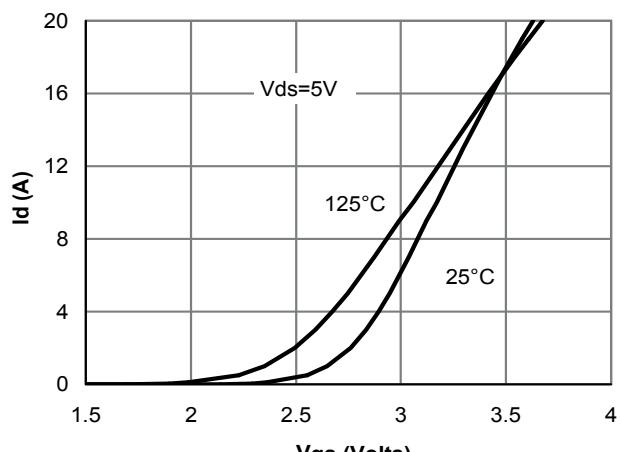


Figure 2: Transfer Characteristics

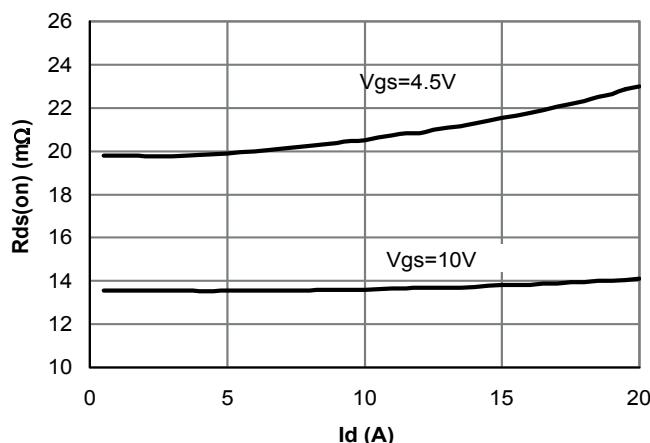


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

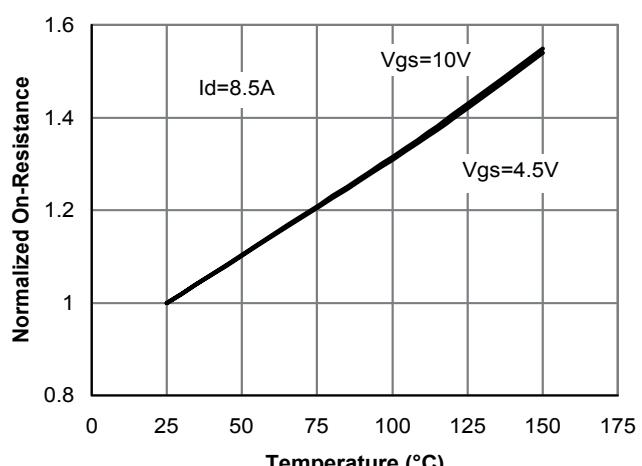


Figure 4: On-Resistance vs. Junction Temperature

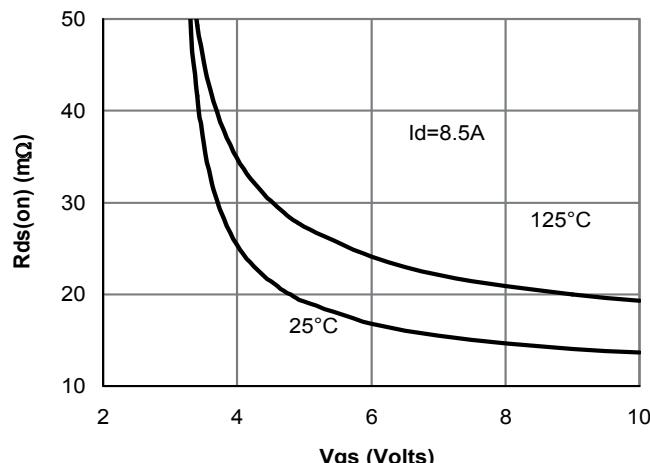


Figure 5: On-Resistance vs. Gate-Source Voltage

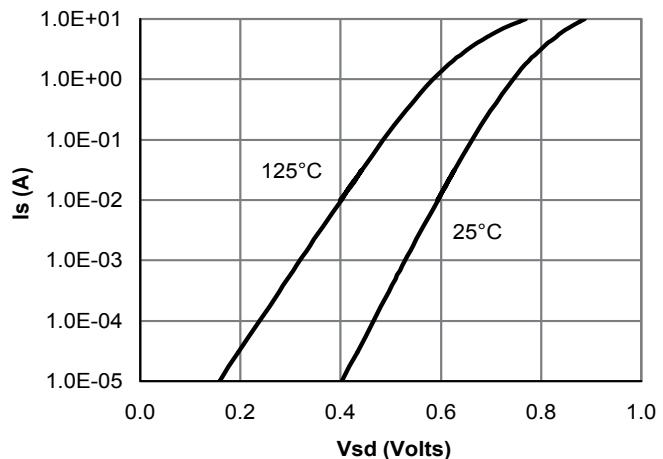


Figure 6: Body-Diode Characteristics

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